L Number	Hits	Search Text	DB	Time stamp
4	633	(359/223).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:11
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
5	304	(359/298).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:16
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
6	581	(359/838).CCLS.	USPAT;	2003/07/30
	301	(00)/000).0020.	US-PGPUB;	08:23
			EPO; JPO;	00.23
			DERWENT;	
			1	
7	88	(205/114) (() 6	IBM_TDB	2002/07/20
′	00	(205/116).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:27
			EPO; JPO;	
			DERWENT;	
	400		IBM_TDB	
8	422	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and (internal with (mirror or reflect\$))	US-PGPUB;	09:34
			EPO; JPO;	
			DERWENT;	
			IBW_TDB	
9	71	(((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and (internal with (mirror or reflect\$))) and	US-PGPUB;	08:31
		anisotrop\$	EPO; JPO;	
			DERWENT;	
			IBW_TDB	i
10	5	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and (internal\$2 with (mirror or reflect\$) with	US-PGPUB;	09:02
		etch\$4)	EPO; JPO;	
			DERWENT;	1 0 1
			IBM_TDB	
11	1	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and (atom\$6 with flat with (mirror or	US-PGPUB;	09:04
		reflect\$) with etch\$4)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
12	6	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and (atom\$6 with flat with (mirror or	US-PGPUB;	09:07
		reflect\$))	EPO; JPO;	
		•••	DERWENT;	
			IBM_TDB	
13	o	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
	-	silicon) and (atom\$6 with flat with anisotrop\$)	US-PGPUB;	09:08
		· · · · · · · · · · · · · · · · · · ·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	·		T	T 4444 144 144
14	2	silicon same (atom\$6 with flat with anisotrop\$)	USPAT;	2003/07/30
			US-PGPUB;	09:10
			EPO; JPO;	
			DERWENT;	
			IBW_TDB	
15	5	silicon same (atom\$6 with flat) same anisotrop\$	USPAT;	2003/07/30
			US-PGPUB;	09:10
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
16	512	((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and ((internal or bur\$3) with (mirror or	US-PGPUB;	09:13
		reflect\$))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
17	356	(((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
		silicon) and ((internal or bur\$3) with (mirror or	US-PGPUB;	09:14
		reflect\$))) and etch\$4	EPO; JPO;	
		, verige 3,777	DERWENT;	
			IBM_TDB	
18	69	(((bulk or (single near3 crystal\$) or homogen\$) near3	USPAT;	2003/07/30
10		silicon) and ((internal or bur\$3) with (mirror or	US-PGPUB;	09:14
		reflect\$))) and (etch\$4 with plane)	EPO; JPO;	0,1.1
		Terreerapy) and (event with plane)	DERWENT;	
			IBM_TDB	
19	166	((bulk or crystal\$ or homogen\$) near3 silicon) and	USPAT;	2003/07/30
17	100	(internal with (mirror or reflect\$ or deflect\$)) and	US-PGPUB;	10:15
		anisotrop\$	EPO; JPO;	10.15
		απισοπορφ	DERWENT;	
			IBM_TDB	
21	324	((bulk or crystal\$ or homogen\$) near3 silicon) and	USPAT;	2003/07/30
21	327	(integra\$ with (mirror or reflect\$ or deflect\$)) and	US-PGPUB;	11:13
		anisotrop\$	EPO; JPO;	11.13
		anisotropp		
			DERWENT;	
22	7	 ("A1825AA" "A657220" "A660017" "A67A020"	IBM_TDB	2003/07/20
46	'	("4182544" "4657339" "4669817" "4674828"	USPAT	2003/07/30
22	6.43	"4675521" "4684208" "4705349").PN.	HEDAT	11:04
23	642	silicon and (integra\$ with (mirror or reflect\$ or	USPAT;	2003/07/30
		deflect\$)) and (anisotrop\$ with etch\$3)	US-PGPUB;	11:16
			EPO; JPO;	
			DERWENT;	
1	400	Contract Con	IBM_TDB	2002/07/22
24	182	(integra\$ with (mirror or reflect\$ or deflect\$)) and	USPAT;	2003/07/30
		(silicon with anisotrop\$ with etch\$3) and (hole or	US-PGPUB;	11:56
		bore or passage)	EPO; JPO;	
			DERWENT;	
		landing the second of the seco	IBM_TDB	
25	84	(silicon with (mirror or reflect\$ or deflect\$) with	USPAT;	2003/07/30
		(micromachin\$ or micro?machin\$)) and (anisotrop\$	US-PGPUB;	11:58
		with etch\$3)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	

			1	0000 (07 (00
26	35	(atom\$6 near3 (smooth\$4 or flat\$4)) with etch\$4	USPAT;	2003/07/30
		with silicon	US-PGPUB;	12:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
27	256	(atom\$6 near3 (smooth\$4 or flat\$4)) and (mirror or	USPAT;	2003/07/30
		reflect\$ or deflect\$) and etch\$4 and silicon	US-PGPUB;	12:26
		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
28	35	((atom\$6 near3 (smooth\$4 or flat\$4)) same (mirror	USPAT;	2003/07/30
20	35	1 **	US-PGPUB;	12:31
		or reflect\$ or deflect\$)) and etch\$4 and silicon		12.51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
29	52	(atom\$6 near3 (smooth\$4 or flat\$4)) and (mirror or	USPAT;	2003/07/30
		reflect\$ or deflect\$) and (anisotrop\$ with etch\$4)	US-PGPUB;	12:32
·		and silicon	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	2	("6008128").PN.	USPAT;	2002/09/17
			US-PGPUB;	09:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	576	(359/223).CCLS.	USPAT;	2003/03/07
	0,0	(607, 220).0000.	US-PGPUB;	17:14
			EPO; JPO;	-,
			DERWENT;	
			IBM_TDB	
	255	(359/298).CCLS.	USPAT;	2003/03/07
-	255	(339/296).0023.	US-PGPUB;	17:14
			1	17.14
			EPO; JPO;	
			DERWENT;	
		(250,020), 441, 6	IBM_TDB	0000 (00 (07
-	505	(359/838).CCLS.	USPAT;	2003/03/07
			US-PGPUB;	17:14
			EPO; JPO;	
			DERWENT;	
1			IBW_LDB	
-	88	(205/116).CCLS.	USPAT;	2003/03/07
			U5-PGPUB;	17:15
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	135	((359/223).CCLS.) and silicon\$	USPAT;	2002/09/17
		•	US-PGPUB;	09:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	05	((250 (200) CCLC) 4 -: :	LICDAT	2002/00/47
-	85	((359/298).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	10:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	66	((359/838).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	10:30
			EPO; JPO;	
			DERWENT;	
			IBW_TDB	
-	8	((205/116).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	10:33
			EPO; JPO;	
			DERWENT;	
		·	IBW_TDB	
-	421	silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
		crystal\$4	US-PGPUB;	10:43
			EPO; JPO;	
			DERWENT;	
	1 1 1		IBM_TDB	
_	46	(silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
		crystal\$4) and inlet and outlet	US-PGPUB;	10:37
			EPO; JPO;	
	14.		DERWENT;	
			IBM_TDB	
_	31	silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
		(crystal\$4 adj plane)	US-PGPUB,	10:51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	89	(single adj crystal adj silicon) and mirror and	USPAT;	2003/07/30
		(crystal\$4 adj plane)	US-PGPUB;	08:28
		(,,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	692	(single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17
		and etch\$3	US-PGPUB;	11:43
			EPO; JPO;	=====
			DERWENT;	
:			IBM_TDB	
_	309	((single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17
		and etch\$3) and anisotrop\$	US-PGPUB;	11:09
		and cremps) and anisotropy	EPO; JPO;	11.07
			DERWENT;	
			IBM_TDB	-
_	101	(((single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17 11:10
- '	101	and etch\$3) and anisotrop\$) and fiber and optic\$4	US-PGPUB;	2002/09/1/ 11:10
		and etenips) and anisotropp) and tiber and opticp4	EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	1

	121	(ginala and amoreal and giliaan) and minut and minut	USPAT;	2002/09/17 14:11
-	121	(single and crystal and silicon) and mirror and plane	US-PGPUB;	2002/09/1/ 14:11
		and etch\$3 and anisotrop\$ and fiber and optic\$4 and		
		internal\$2	EPO; JPO;	
			DERWENT;	
			IBM_TDB	2000/00/47
-	256	singl and crystal\$4 and silicon and mirror and	USPAT;	2002/09/17
		etch\$3 and stripe and intersect\$4	US-PGPUB;	14:25
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	118	(single and crystal\$4 and silicon and mirror and	USPAT;	2002/09/17
		etch\$3 and stripe and intersect\$4) and internal	US-PGPUB;	11:58
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	373	(single near crystal\$4 near silicon) with mirror	USPAT;	2002/09/17
			US-PGPUB;	12:05
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	39	((single near crystal\$4 near silicon) with mirror) and	USPAT;	2002/09/17
		(fiber near optic\$4)	US-PGPUB;	12:06
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	3645	digital and mirror and device and silicon and	USPAT;	2002/09/17
		crystal\$4	US-PGPUB;	14:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	168	(digital and mirror and device and silicon and	USPAT;	2002/09/17
		crystal\$4) and bulk and monolith\$	US-PGPUB;	14:12
		, , , , , , , , , , , , , , , , , , , ,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	341	silicon and mirror and etch\$3 and stripe and	USPAT;	2002/09/17
		intersect\$4	US-PGPUB;	14:36
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	2259	silicon and mirror and pattern\$3 and anisotrop\$	USPAT;	2002/09/17
		amount and minitor and particities and amount ope	US-PGPUB;	14:37
			EPO; JPO;	- 1.07
			DERWENT;	
			IBM_TDB	
_	403	(single adj crystal\$4 adj silicon) and mirror and	USPAT;	2002/09/17
· —·	703	pattern\$3 and anisotrop\$	US-PGPUB;	15:20
		ן אינ ופו וואס מוום מוווסט וויטף ש 	EPO; JPO;	13.20
		,	DERWENT;	
			IBM_TDB	
			TOW_IDE	L

		7(t) 1) 7 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	LICDAT	2002/00/47
-	0	(bulk with (single adj crystal\$4 adj silicon)) and	USPAT;	2002/09/17
		(mirror near pattern\$3)	US-PGPUB;	15:22
			EPO; JPO;	
	•		DERWENT;	
			IBM_TDB	
-	20	silicon and (mirror near patt rn\$3) and (anisotrop\$	USPAT;	2002/09/17
		near etch\$3)	US-PGPUB;	15:34
			EPO; JPO;	
			DERWENT;	
			IBW_TDB	
-	16	silicon and ((mirror near pattern\$3) with array\$)	USPAT;	2002/09/17
			US-PGPUB;	15:39
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	2585	(mirror with array\$) and silicon	USPAT;	2002/09/17
		, · ·	US-PGPUB;	16:16
			EPO; JPO;	
	1		DERWENT;	
			IBM_TDB	
_	9	(mirror with array\$) and (bulk with single with	USPAT;	2002/09/17
		crystal\$4 with silicon)	US-PGPUB;	15:43
		Ciyaraiq i wim amoony	EPO; JPO;	13.10
			DERWENT;	
			IBM_TDB	
	2	((mirror with array\$) and silicon) and anisotrop\$ and	USPAT;	2002/09/17
1	_	(bulk near crystal\$4)	US-PGPUB;	15:44
		(but hear crystalpy)	EPO; JPO;	15.44
			DERWENT;	
			IBM_TDB	
	2	monolithic adj bulk adj crystal adj silicon	USPAT;	2002/09/17
-		mononthic day bulk day crystal day silicon	US-PGPUB;	16:17
				10.17
			EPO; JPO; DERWENT;	
	2	سميمانغان المعربية المسام المناس المن	IBM_TDB	2002/09/17
-		monolithic with bulk with crystal with silicon	USPAT; US-PGPUB;	16:17
			1	10.17
			EPO; JPO;	
			DERWENT;	
	150/	manualistic and halls and amorable and with an	IBM_TDB	2002/00/47
-	1586	monolithic and bulk and crystal and silicon	USPAT;	2002/09/17
			US-PGPUB;	16:18
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	25	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline near plane)	US-PGPUB;	16:19
			EPO; JPO;	
			DERWENT;	
	<u></u>		IBM_TDB	

-	362	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline and plane)	US-PGPUB;	16:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	4	((monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline and plane)) and (micro?mirror or (micro	US-PGPUB;	16:20
		adj mirror))	EPO; JPO;	10.20
			DERWENT;	
			IBM_TDB	
	109	((monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
_	109	(crystalline and plane)) and mirror	US-PGPUB;	16:41
		(crystamine and plane)) and mirror	EPO; JPO;	10.41
			DERWENT;	
		and the second s	IBM_TDB	2002/00/47
-	4	silicon near mirror near array	USPAT;	2002/09/17
	1		US-PGPUB;	16:42
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1415	digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device	US-PGPUB;	16:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	350	(digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device) and silicon	US-PGPUB;	17:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	16	(digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device) and (single adj crystal adj	US-PGPUB;	17:14
		silicon)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	3991	(mirror or reflect\$) and (single adj crystal adj	USPAT;	2002/09/17
		silicon)	US-PGPUB;	17:16
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	240	((mirror or reflect\$) and (single adj crystal adj	USPAT;	2002/09/17
		silicon)) and bulk and monolith\$	US-PGPUB;	17:42
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	148	anisotrop\$ with silicon with array with etch\$4	USPAT;	2002/09/17
		Share and an animal and an animal and animal	US-PGPUB;	17:43
			EPO; JPO;	-7•
			DERWENT;	
			IBM_TDB	
	1		I TOW_IDD	1

	226	(anisotrop\$ with silicon with process\$) and (mirror or	USPAT;	2002/09/17
-	220	- · · · · · · · · · · · · · · · · · ·	US-PGPUB;	18:38
		refl ctor)		10:30
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2000/00/47
-	25	silicon and mirror and passage and (crystalline adj	USPAT;	2002/09/17
		plane)	US-PGPUB;	18:42
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	42	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(mirror or reflector) and crystalline and plane and	US-PGPUB;	18:44
		intersect\$4	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	606	(359/223).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:10
			EPO; JPO;	
	i ·		DERWENT;	
			IBM_TDB	
-	290	(359/298).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:10
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	553	(359/838).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:10
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	88	(205/116).CCLS.	USPAT;	2003/07/30
			US-PGPUB;	08:10
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	42	((359/223).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
		anisotrop\$	US-PGPUB;	17:28
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	23	((359/298).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
		anisotrop\$	US-PGPUB;	17:52
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	15	((359/838).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
-		anisotrop\$	US-PGPUB;	17:54
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

-	1	((205/116).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
:		anisotrop\$	US-PGPUB;	17:56
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	244	silicon and ((mirror or reflector) with anisotrop\$)	USPAT;	2003/03/10
			US-PGPUB;	08:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
l <u>-</u>	2	westra.in. and silicon and anisotrop\$	USPAT;	2003/03/10
		, .	US-PGPUB;	08:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	101	westra.in.	USPAT;	2003/03/10
			US-PGPUB;	08:21
			EPO; JPO;	
-	1		DERWENT;	
			IBM_TDB	